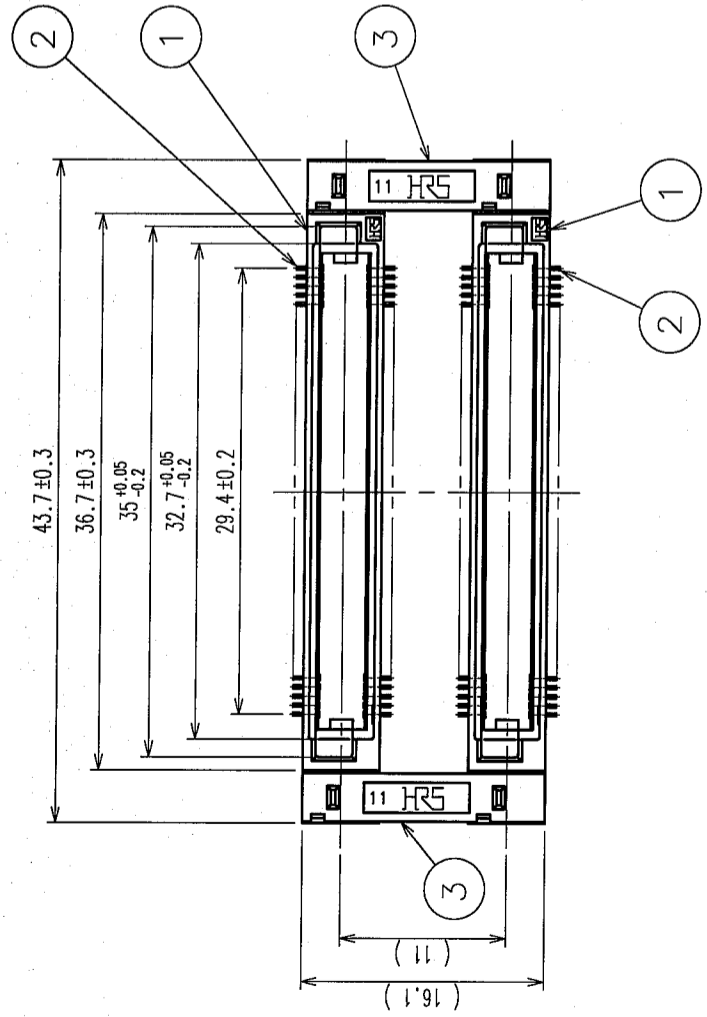
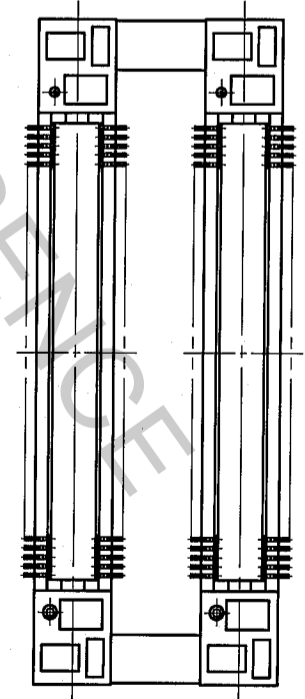
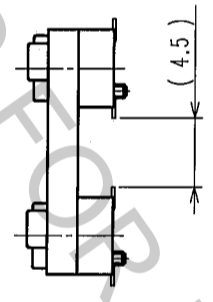
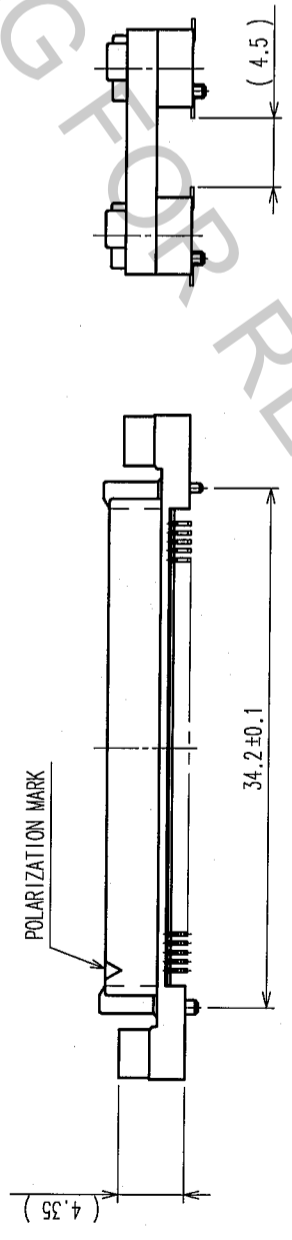
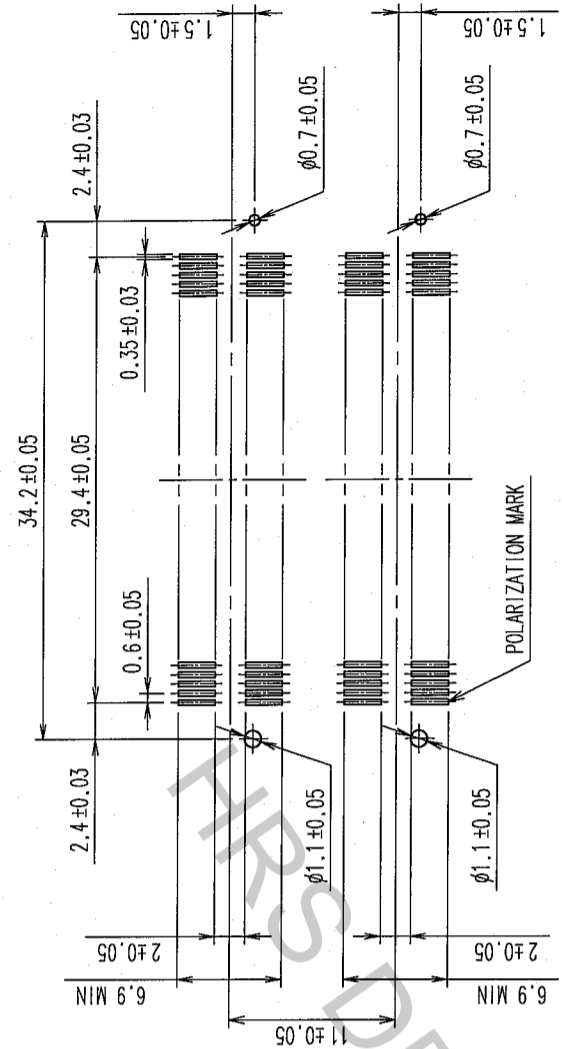


NO.	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
1					1				
2					1				
3					1				



RECOMMENDED LAND PATTERN DIMENSION OF PCB(MOUNTING SIDE)



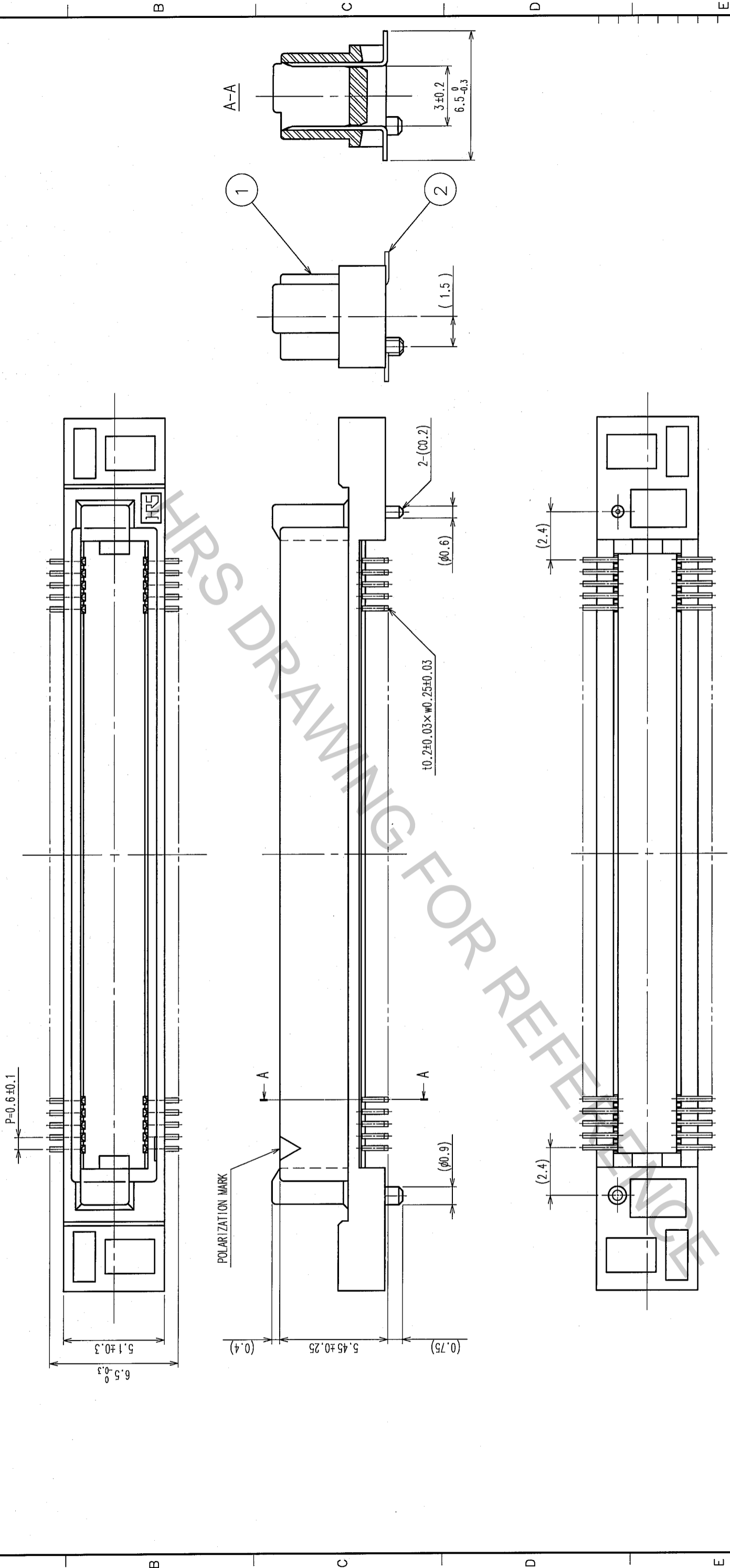
- NOTES
- 1 LEAD CO-PLANARITY SHALL BE 0.1mm MAX.
 - 2 AFTER MOUNTING BOARD, REF.NO.3 SHALL BE REMOVED.
 - 3 FOR MODIFICATION, ETC., PREVENTIVE HOLE FOR SINK MARK MAY BE ADDED DEPENDS ON CIRCUMSTANCES.
 - 4 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

1, 3	PPS	LIGHT BROWN (UL94V-0)	2	PHOSPHOR BRONZE	CONTACT AREA : GOLD 0.1μm min. LEAD AREA:TIN-PLATING 1μm min. UNDER PLATING:NICKEL 1μm min.
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
CODE NO.(OLD) CL			DRAWN T. YANAGISAWA	DESIGNED <i>N. Nakamura</i>	CHECKED <i>H. Okawa</i>
			'06.02.02	'06.02.02	'06.02.02
DRAWING NO. EDC3-150913-25		PART NO. FX8C-100/100P11-SV1J(71)			
SCALE 2 : 1		CODE NO. CL578-0675-0-71			
UNITS MM		HIROSE ELECTRIC CO., LTD			

TO

COUNT		DESCRIPTION OF REVISIONS		BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS		BY	CHKD	DATE
△	△						△					
△	△						△					

DETAIL AFTER REMOVING JOINT



NOTES THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
CODE NO. (OLD)			DRAWN	DESIGNED	CHECKED
			T. YANAGISAWA	H. Nakamura	H. Okawa
			'06.02.02	'06.02.02	'06.02.02
DRAWING NO.		PART NO.		FINISH, REMARKS	
EDC3-150913-25		FX8C-100/100P11-SV1J(71)		APPROVED	
SCALE		CODE NO.		RELEASED	
5 : 1		CL578-0675-0-71		H. Okawa	
UNITS		HIROSE ELECTRIC CO., LTD		'06.02.02	
ITTT					

TO	